

6.0V / 2.0A / 1.2MHz Synchronous Step-Down Converter

Features

- Wide input range of V_{IN} from 2.5V to 6.0V
- Output voltage range from 0.6 V to V_{DD}
- Internal low on-resistance switches
 - High-Side $R_{DS(ON)}$ 100m Ω
 - Low-Side $R_{DS(ON)}$ 100m Ω
- 100% duty cycle operation
- Switching frequency: 1.2MHz
- PFM mode operation when no load/light load conditions
- Output voltage power good indicator when $V_{OUT}=0.95 \times V_{OUT(TARGET)}$ (8SOP-EP)
- Low IC surface temperature in short circuit protection
- Protection features
 - V_{DD} under voltage lock-out
 - · Cycle-by-Cycle over current protection
 - Thermal shutdown protection
 - · Output short-circuit protection
 - · Output over-voltage protection
- Package types: 8-pin SOP-EP and 5-pin SOT23

Applications

- Single Li-Battery applications and small motor driver applications
- Rechargeable AA batteries
- · Laser demarcation device
- · Portable toy
- 5V USB/Adaptor power source
- · 3.3V DC source

General Description

The HT74153 is a high efficiency synchronous step-down converter capable of delivering 2A output current. It can operate over a wide input voltage range from 2.5V to 6.0V and integrates $100 \mathrm{m}\Omega$ low on-resistance main and rectified switches to minimize the conduction losses. Up to 1.2MHz switching frequency in PWM allows to use the small surface mount inductors and capacitors in applications.

The automatically PWM/PFM mode switching is useful to drive up to 2A load current and also decrease its standby current in no load condition. The Hysteretic PFM mode extends the battery life by reducing the quiescent current during the system standby. In the shutdown mode, the device turns off and consumes only $0.1\mu A$ input current.

The HT74153 also provides 100% duty cycle operation. When the input supply voltage decreases toward the targeted output voltage, the High-Side MOSFET will always turn on and the output voltage tracks the input voltage, which can extend the battery life

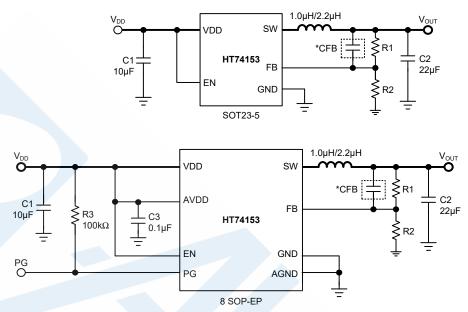


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Typical Application Circuit

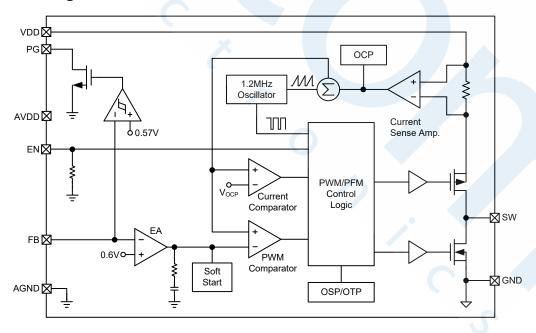


Note: *CFB option is recommended to refer the "Application Information-Load Transient Compensation Design" chapter.

Selection Table

Part No.	Package	Marking
HT74153	8SOP-EP	HT74153
П174153	SOT23-5	4153

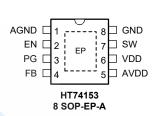
Block Diagram

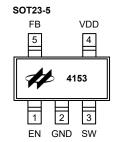


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Pin Assignment





Pin Description

Pin	Pin	No.	Type	Deceriation	
Name	8SOP-EP	SOT23-5	Type	Description	
AGND	1	_	G	Analog ground pin	
EN	2	1		Chip enable pin. High Active. Internally connect a 1MΩ pull down resistor	
PG	3	_	0	Output power good indicate pin. Connect a 100kΩ pull up resistor to VDD	
FB	4	5	1	Output voltage feedback pin. Set output voltage via resistor dividers R1 and R2	
AVDD	5	_	Р	Analog input pin. Connect a 0.1µF ceramic capacitor to GND at least	
VDD	6	4	Р	Power input pin. Connect a 10µF ceramic capacitor to GND at least	
SW	7	3	0	Switching node. Connect to power inductor	
GND	8	2	G	Power ground pin	
EP			G	Exposed pad. Connect to AGND	

Absolute Maximum Ratings

Parameter	Parameter		
VDD, AVDD		-0.3 ~ +6.4	V
SW		-0.3 ~ (V _{DD} +0.3)	V
EN, PG, FB		-0.3 ~ +6.4	V
Operating Temperature Range	X	-40 ~ +85	°C
Output Current		Thermal Limits	_
Maximum Junction Temperature		+150	°C
Storage Temperature Range		-60 ~ +150	°C
Lead Temperature (Soldering 10sec)		+300	°C
ESD Susceptibility	Human Body Model	4000	V
ESD Susceptibility	Machine Model	200	V
Junction-to-Ambient Thermal Resistance, θ _{JA}	8SOP-EP	125	°C/W
Junction-to-Ambient Memai Resistance, 6JA	SOT23-5	220	C/VV

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Recommended Operating Range

Parameter	Value	Unit
V _{DD} , AV _{DD}	2.5 ~ 6.0	V
I _{OUT(MAX)}	2	A

Note that Absolute Maximum Ratings indicate limitations beyond which damage to the device may occur. Recommended Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specified performance limits.

Electrical Characteristics

 V_{DD} =A V_{DD} =3.6V, Ta=25°C, unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Supply Voltage						
V_{DD}	Input Voltage	V _{DD} =AV _{DD}	2.5	_	6.0	V
	land to Committee Committee	I _{AVDD} +I _{VDD} , PWM, V _{FB} =0.58V	_	170	210	
I _{DD}	Input Supply Current	I _{AVDD} +I _{VDD} , PFM, V _{FB} =0.62V	_	50	70	μA
I _{OFF}	Shutdown Current	I _{AVDD} +I _{VDD} , V _{AVDD} =V _{VDD} =5V, V _{EN} =0V	_	0.1	0.5	μΑ
Buck Con	verter					
Vout	Output Voltage	_	0.6	_	V_{DD}	V
fsw	Switching Frequency	V _{FB} =0.58V	960	1200	1440	kHz
T _{ON(min)}	Minimum ON-Time	_	_	100		ns
R _{DS(on)_P}	PMOS Switch-ON Resistance	_	_	100	_	mΩ
R _{DS(on)_N}	NMOS Switch-ON Resistance	_	_	100	_	mΩ
I _{LEAK}	SW Leakage Current	V_{EN} =0V, V_{SW} =0V to V_{DD} . Measure I_{SW}	_	0.1	1.0	μA
V_{FB}	Feedback Voltage	2.5V≤V _{DD} ≤6V	591	600	609	mV
I _{FB}	FB Leakage Current	V _{FB} =5V	_	_	0.1	μΑ
ViH	EN High Voltage Threshold	2.5V≤V _{DD} ≤6V	1.2	_	_	V
V _{IL}	EN Low Voltage Threshold	2.5V≤V _{DD} ≤6V	_	_	0.4	V
R _{PD_EN}	EN Pull Down Resistor	_	_	1	_	ΜΩ
Protection	าร					
V _{UVLO+}	Input Supply Turn ON Level	UVLO+	_	_	2.1	V
V _{UVLO-}	Input Supply Turn OFF Level	UVLO-	1.6	_		V
I _{OCP}	Over Current Protection Threshold	_	_/	3.2		Α
Vosp	Output Short-Circuit Threshold	Measure FB	_	300		mV
Tosp	OSP Repeat Time	/ -	_	21	_	ms
T _{SHD}	Thermal Shutdown Threshold	OTP	_	150	_	°C
T _{HYS}	Thermal Shutdown Hysteresis	_		15	_	°C
Others						
R _{PG}	PG Threshold	Measure FB, V _{FB_PG} /V _{FB}		95	_	%
V _{PG(OL)}	PG Sink Capability	V _{FB} =0.5V. Source 1mA to PG, measure PG	_	_	0.4	V
Tss	Soft Start Time	_	_	0.7		ms
V _{FB_OVP}	Prevent Output Overshoot	_	640	660	680	mV

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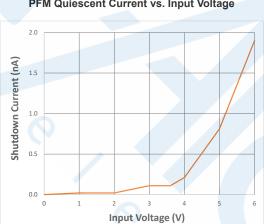


Typical Performance Characteristics

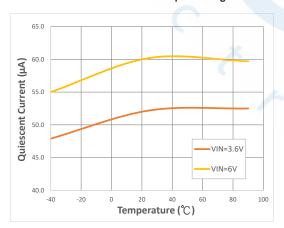


PFM Quiescent Current vs. Input Voltage

Input Voltage (V)

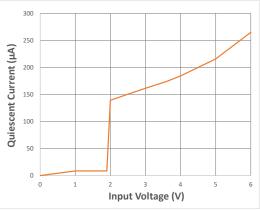


Shutdown Current vs. Input Voltage

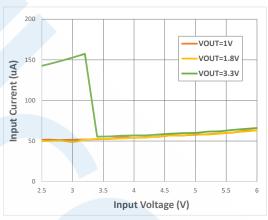


PFM Quiescent Current vs. Temperature

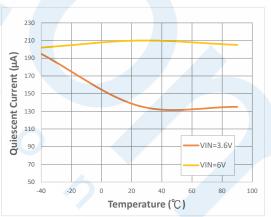
V_{DD}=AV_{DD}=3.6V, Ta=25°C, unless otherwise noted



PWM Quiescent Current vs. Input Voltage



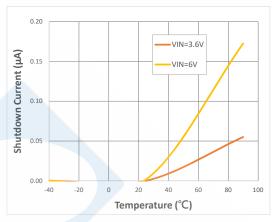
No Load Current vs. Input Voltage

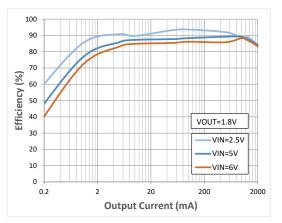


PWM Quiescent Current vs. Temperature

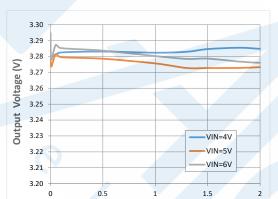
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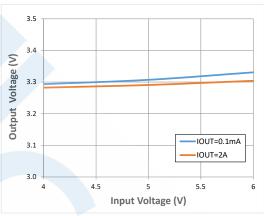




Shutdown Current vs. Temperature

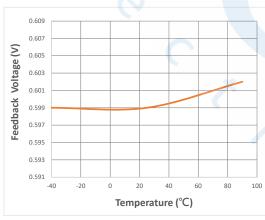


Efficiency vs. Load

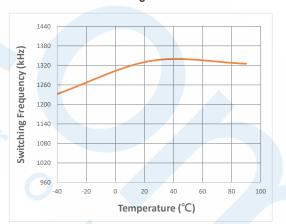


Output Current (A)

Load Regulation



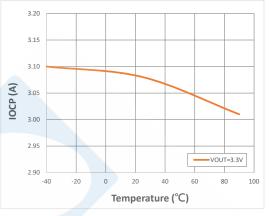
Line Regulation

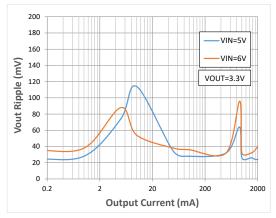


Feedback Voltage vs. Temperature

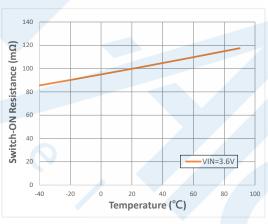
fsw vs. Temperature



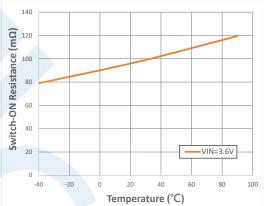




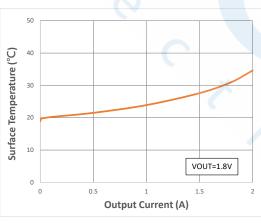
I_{ocp} vs. Temperature



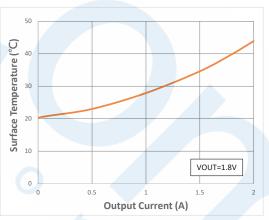
V_{OUT} Ripple



PMOS Switch-ON Resistance vs. Temperature



NMOS Switch-ON Resistance vs. Temperature

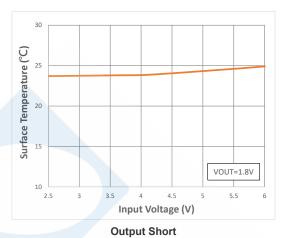


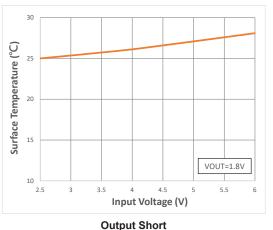
Surface Temperature vs. Output Current (8SOP-EP)

Surface Temperature vs. Output Current (SOT23-5)

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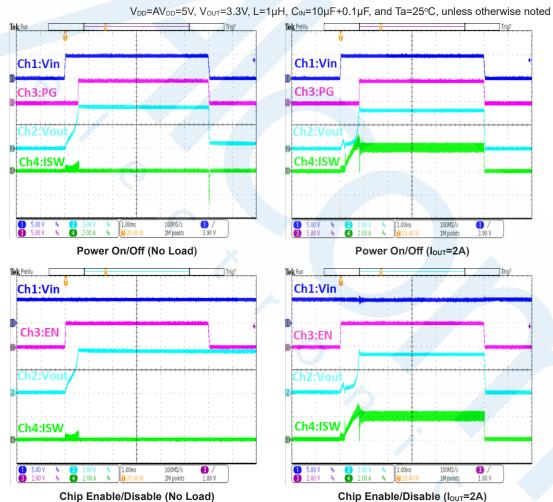




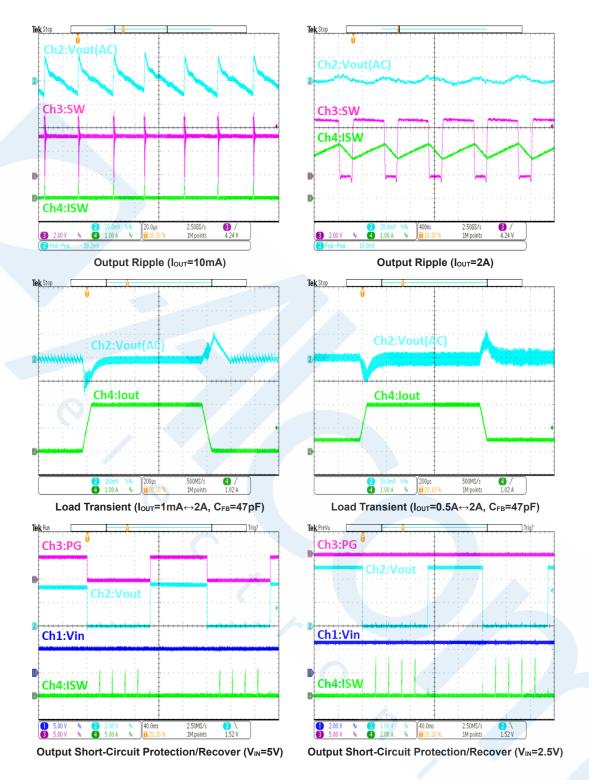
Surface Temperature vs. Input Voltage (8SOP-EP)

Surface Temperature vs. Input Voltage (SOT23-5)

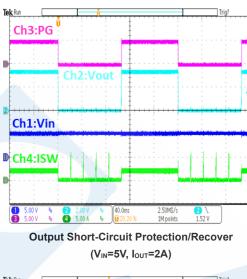
Typical Performance Characteristics (Continued)

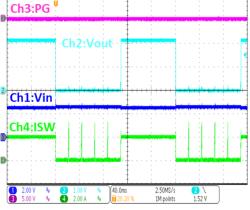


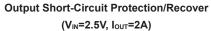


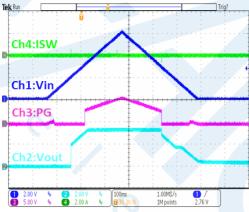


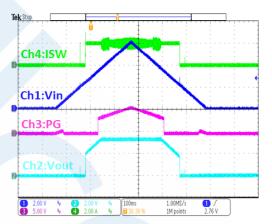






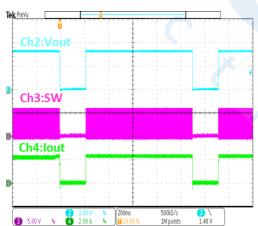






100% Duty Cycle Operation/Recover (No Load)

100% Duty Cycle Operation/Recover (Iout=2A)



Thermal Shutdown/Recover



Functional Description

PWM/PFM Control Operation

Depends on the output current requirement, the HT74153 realizes 3 kinds of operation modes: PWM Mode, PFM Mode and Shutdown Mode. When the light load current, the device operates in the PFM mode to reduce the input current consumption and improve the efficiency. The heavier load current drives the HT74153 enters the PWM mode automatically to keep the high efficiency and better transient response. In the Shutdown mode, the HT74153 turns off all devices to offer down to $0.1\mu A$ input current consumption.

100% Duty Cycle Operation

When the input supply voltage decreases toward the targeted output voltage, the duty cycle increases to 100% to extend the battery life, and the output voltage tracks the input voltage minus the voltage drop cross the internal High-Side MOSFET and inductor. In this condition, the PG signal is pulled low because the V_{OUT} drops to 95%.

Start-up/Soft Start

The soft start function is realized 0.7ms that smooth the output voltage and prevent the large input inrush current via controlled-charging an internal soft start capacitor during power start-up. The soft start is only activated when EN pin goes from low to high after $V_{IN} \ge 2.1 V$ (V_{UVLO+}). During the soft start procedure, the OSP detection is ignored. The start-up time depends on the output capacitance and demand load current during power start-up. Note that the temperature T_j should be less than (T_{SDH} - T_{HYS}) during power start-up.

Output Voltage Setting

The external resistor divider sets the output voltage, for details see the Application Circuit. The feedback resistor, R1, also sets the feedback loop bandwidth with the internal compensation capacitor. R2 is calculated in equation below and recommended less than $200k\Omega$.

$$R2=R1/[(V_{OUT}/0.6V)-1]$$
 (Ω)

Power Good Indicator

The open-drain type output requires a pull-up resistor on the PG pin. When the output voltage is rising, the PG pin is driven down internally in soft start, shutdown periods and released until the FB voltage exceeds 95% of nominal regulation target voltage, i.e. 0.57V. In addition, there's a debounce time around 80µs after the FB voltage drops to 0.57V in order to prevent the misoperation.

Under Voltage Lock-Out Protection (UVLO)

The HT74153 implements the input Under Voltage Lock-Out (UVLO) function to prevent the misoperation during power on procedure. When the input voltage exceeds $V_{\rm UVLO^+}$, the converter starts operating. On the contrary, when the input voltage falls below $V_{\rm UVLO^-}$, the converter shuts off the output. The hysteresis voltage is designed to prevent the noise-caused reset.

Over Current Protection (OCP)

The HT74153 has a 3.2A (I_{OCP}) peak current for monitoring the internal High-Side switch (P-type MOSFET). When the OCP threshold is detected, the internal High-Side switch is turned off and the internal Low-Side switch (N-type MOSFET) is turned on until next cycle. It is used to protect the external power inductor to exceed its saturation current. When the OCP function occurs, the input peak current is limited and the output voltage is decreased.

Output Short Circuit Protection (OSP)

When the FB voltage is drop below 300mV, the HT74153 enters the output short-circuit protection (OSP) mode. In the OSP mode, the HT74153 enters the hiccup mode, disables both High/Low-Side MOSFETs and discharges the internal soft-start capacitor. After T_{OSP} rest to avoid the heating accumulation, the HT74153 reacts the soft-start procedure until the output short-circuit phenomenon ceases.

Over-Voltage Protection (OVP)

The HT74153 has an over-voltage protection function when the V_{FB} is over 660mV (V_{FB_OVP}). When the HT74153 enters the over-voltage protection function, both the high/low-side MOSFETs are disable. Until the V_{FB} is lower than V_{FB_OVP} in next cycle, the HT74153 exits the protection and the MOSFETs start to operate.

Thermal Shutdown (OTP)

If the die temperature exceeds the internal limit threshold, T_{SHD} , the device will turn off all power MOSFETs until the temperature decreases to a specific level less than the recovery temperature, T_{HYS} .

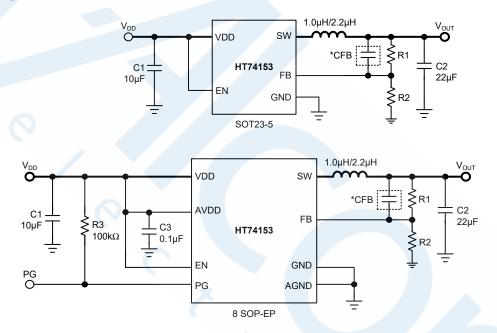
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Protection Type	Trigger Condition	V _{out} &PG	Recovery Condition	
Under Voltage Lockout	V _{IN} is lower than V _{UVI 0-}	V _{OUT} is 0V	\\ is higher than \\	
(UVLO)	VIN IS IOWEI LIIAII VUVLO-	PG is LOW	V _{IN} is higher than V _{UVLO+}	
Over Current Protection		V _{OUT} drop depends on duty cycle	l is lower than l in	
(OCP)	I _L rises to I _{OCP}	PG is LOW when V _{OUT} is lower 95% over 80µs		
Output Short Circuit	\/ drapa to \/	V _{OUT} is 0V	V _{FB} is higher than V _{OSP}	
Protection (OSP)	V _{FB} drops to V _{OSP}	PG is LOW when OSP is over 80µs	after Tosp+Tss	
Over Voltage Protection	V is ever V	Peak V _{OUT} is 110% V _{OUT}	V _{FB} is lower than V _{FB_OVP}	
(OVP)	V _{FB} is over V _{FB_OVP}	PG is HIGH	in next cycle	
Over Temperature	Ti io over T	V _{OUT} drops to 0V	Ti daaraaaa ta T	
Protection (OTP)	Tj is over T _{SHD}	PG is LOW when OTP is over 80µs	Tj decreases to T _{HYS}	

List of Protection Function

Component Selection Guide



Recommended Component Values

Reference	Value	Description	Part Number	Manufacturer
C1	10µF	Capacitor, Ceramic, 10µF,10V, X7R, 0805	LMK212B7106KG-TD	Taiyo Yuden
C2	22µF	Capacitor, Ceramic, 22µF, 25V, X5R, 0805	GRM21BR61E226ME44L	Murata
C3	0.1µF	Capacitor, Ceramic, 0.1µF, 50V, X5R, 0603	0603B104K500CT	Walsin
*CFB	47pF	Capacitor, Ceramic, 47pF, 50V, NPO, 0603	GRM1885C1H470JA01D	Murata
L1	1.0µH	Inductor, 7.1mΩ, I _{Rate} =14.1A, 7.1mm×6.5mm×3mm	SPM6530T-1R0M120	TDK
L 1	2.2µH	Inductor, 17.3mΩ, I _{Rate} =8.4A, 7.1mm×6.5mm×3mm	SPM6530T-2R2M	TDK
R3	100kΩ	Resistor, Chip, 1%, 0603		

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V _{OUT} (V)	Package	R1 (kΩ)	R2 (kΩ)
1.8		400 (±1%)	200 (±1%)
2.5	SMD 0603	630 (±1%)	200 (±1%)
2.7		700 (±1%)	200 (±1%)
3.0		800 (±1%)	200 (±1%)
3.3		900 (±1%)	200 (±1%)

Note: 1. $V_{OUT}=0.6V\times(R1+R2)/R2$.

 *CFB option is recommended to refer the "Application Information-Load Transient Compensation Design" chapter.

Power Inductor

Use an inductor with a DC current rating at least 25% percent higher than the maximum load current for most applications. The DC resistance of the inductor is a key parameter for the efficiency. Concerned efficiency, the inductor's DC resistance should be less than $200 \text{m}\Omega$. For most application, the inductor value can be calculated from the following equation.

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times I_{ripple} \times f_{SW}}$$

A higher value of ripple current reduces the inductance value, but increases the conductance loss, core loss, and current stress for the inductor and switch devices. A suggest choice is for the inductor ripple current to be 30% of the maximum load current.

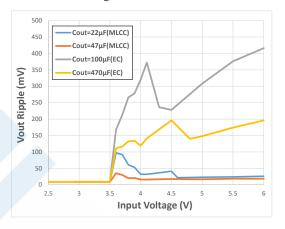
Input Capacitor

A low ESR ceramic capacitor, C_{IN} , is needed between the VIN pin and GND pin. Use ceramic capacitors with X5R or X7R dielectrics for their low ESRs and small temperature coefficients. For most applications, above $10\mu F$ capacitor will sufficient.

Output Capacitor

The selection of C_{OUT} is driven by the maximum allowable output voltage ripple. Use ceramic capacitors with X5R or X7R dielectrics for their low ESR characteristics. The capacitor value is good starting point with an ESR or 0.1Ω or less and should be over $22\mu F$.

The selection of COUT is driven by the maximum allowable output voltage ripple. Use ceramic capacitors with X5R or X7R dielectrics for their low ESR characteristics. The capacitor value is good starting point with an ESR or 0.1Ω or less and capacitance should be in the range of $10\mu\text{F}$ to $470\mu\text{F}$. It is neceecry to use MLCC in low output voltage ripple application. Only ceramics have the extremely low ESR that is needed to. The comparison of low ESR and non-low ESR is shown in Fig.1.



Application Information

Interference Consideration

If the external interference or PCB noise is too high in the application environment, causing output voltage too high, it is recommended that the FB resistor set as 1/10 of the recommended value table, it is also recommended a large ground plane to improve PCB noise and long-term reliability. C3, R1, R2 loop as close as possible to the HT74153.

Load Transient Compensation Design

The HT74153 utilizes current-mode control to regulate the output voltage. When a load step occurs, PFM/PWM control logic takes several cycles to respond to a step in load current, causing output voltage rapid drop. Thus, adding a 47pF capacitor CFB will improve output voltage drop when load transient occurs.

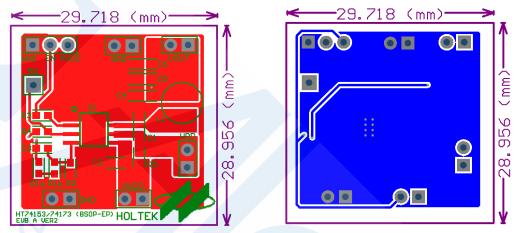
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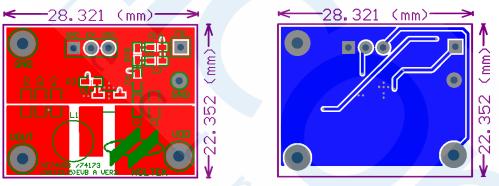
Layout Consideration Guide

To achieve the best efficiency and to reduce the conducted noise, there are some important points to note regarding the PCB layout.

- 1. The input/output capacitors and the inductor should be placed as close as possible to the IC.
- 2. Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the FB pin as possible, but should not be close to the SW nodes to avoid noise interference.
- 3. L1 should be placed as close to the IC as possible. Minimize the noise from the switch node.
- 4. Use wide and short traces for the main current paths to reduce the parasitic inductance and resistance.



8SOP-EP PCB Layout Example



SOT23-5 PCB Layout Example

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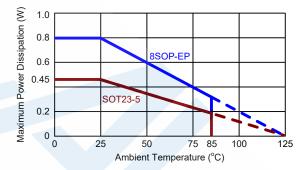
Thermal Considerations

The maximum power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of the surrounding airflow and the allowed difference between the junction and ambient temperatures. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_a) / \theta_{JA} \qquad (W)$$

Where $T_{J(MAX)}$ is the maximum junction temperature, T_a is the ambient temperature and θ_{JA} is the junction to ambient thermal resistance of IC package (125°C/W for 8-pin SOP-EP).

For maximum operating rating conditions, the maximum junction temperature is 150°C. However, it's recommended that the maximum junction temperature does not exceed 125°C in normal operation to keep high reliability. The derating curve of maximum power dissipation is as follows:



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Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the <u>Holtek website</u> for the latest version of the <u>Package/Carton Information</u>.

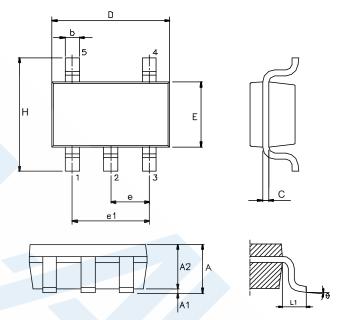
Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

- Package Information (include Outline Dimensions, Product Tape and Reel Specifications)
- Packing Meterials Information
- · Carton information

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5-pin SOT23 Outline Dimensions



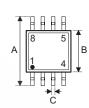
Symbol	Dimensions in inch			
Syllibol	Min.	Nom.	Max.	
A	_	_	0.057	
A1	_	_	0.006	
A2	0.035	0.045	0.051	
b	0.012	_	0.020	
С	0.003	_	0.009	
D	_	0.114 BSC	_	
E	_	0.063 BSC	_	
е	_	0.037 BSC	_	
e1		0.075 BSC	_	
Н	_	0.110 BSC	_	
L1	- X	0.024 BSC		
θ	0°	_	8°	

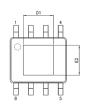
Symbol		Dimensions in mm	
Symbol	Min.	Nom.	Max.
A	_		1.45
A1	_	0 - 0	0.15
A2	0.90	1.15	1.30
b	0.30	-	0.50
С	0.08		0.22
D	_	2.90 BSC	_
Е	_	1.60 BSC	_
е	_	0.95 BSC	_
e1	_	1.90 BSC	
Н	_	2.80 BSC	
L1	_	0.60 BSC	_
θ	0°	_	8°

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8-pin SOP-EP (150mil) Outline Dimensions









Cumbal	Dimensions in inch			
Symbol	Min.	Nom.	Max.	
A	_	0.236 BSC	_	
В	_	0.154 BSC		
С	0.012	_	0.020	
C'	_	0.193 BSC		
D	_	_	0.069	
D1	0.059	_	_	
E	_	0.050 BSC	_	
E2	0.039	_	_	
F	0.000		0.006	
G	0.016	_	0.050	
Н	0.004		0.010	
α	0°	_	8°	

Cumbal	Dimensions in mm			
Symbol	Min.	Nom.	Max.	
A	<u> </u>	6.00 BSC	_	
В	_	3.90 BSC	_	
С	0.31	_	0.51	
C'	_<	4.90 BSC		
D		_	1.75	
D1	1.50	_	_	
E	_	1.27 BSC	_	
E2	1.00	<u> </u>	_	
F	0.00	0 - (0.15	
G	0.40	_	1.27	
Н	0.10	-6	0.25	
α	0°		8°	

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